TOIREX

XP132A1545SR

ETR1109_001

Power MOSFET

■ GENERAL DESCRIPTION

The XP132A1545SR is a P-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

The small SOP-8 package makes high density mounting possible.

■APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■FEATURES

Low On-State Resistance : $Rds(on)=0.03 \Omega (Vgs=-10V)$

: Rds(on)= 0.045Ω (Vgs=-4.5V)

Ultra High-Speed Switching

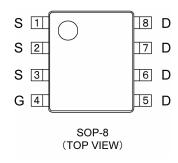
Driving Voltage : -4.5V

P-Channel Power MOSFET

DMOS Structure

Package : SOP-8

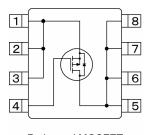
■PIN CONFIGURATION



■PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1~3	S	Source
4	G	Gate
5~8	D	Drain

■EQUIVALENT CIRCUIT



P-channel MOSFET (1 device built-in)

■ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

1a - 25 ·					
SYMBOL	RATINGS	UNITS			
Vdss	-30	٧			
Vgss	±20	٧			
ld	-8	Α			
ldp	-32	Α			
ldr	-8	Α			
Pd	2.5	W			
Tch	150	ပွ			
Tstg	-55~150	တ			
	Vdss Vgss Id Idp Idr Pd Tch	SYMBOL RATINGS Vdss -30 Vgss ±20 Id -8 Idp -32 Idr -8 Pd 2.5 Tch 150			

^{*} When implemented on a glass epoxy PCB

■ELECTRICAL CHARACTERISTICS

DC Characteristics Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds=-30V, Vgs=0V	-	-	-10	μΑ
Gate-Source Leak Current	lgss	Vgs=±20V, Vds=0V	-	-	±1	μΑ
Gate-Source Cut-Off Voltage	Vgs(off)	Id=-1mA, Vds=-10V	-1.0	-	-2.5	٧
Drain-Source On-State Resistance *	Rds(on)	Id=-4A, Vgs=-10V	-	0.025	0.030	Ω
		Id=-4A, Vgs=-4.5V	-	0.038	0.045	Ω
Forward Transfer Admittance *	Yfs	Id=-4A, Vds=-10V	-	11	-	S
Body Drain Diode Forward Voltage	Vf	If=-8A, Vgs=0V	-	-0.85	-1.1	V

^{*} Effective during pulse test.

Dynamic Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds=-10V, Vgs=0V f=1MHz	ı	1500	ı	pF
Output Capacitance	Coss		-	1000	-	pF
Feedback Capacitance	Crss		-	500	-	pF

Switching Characteristics

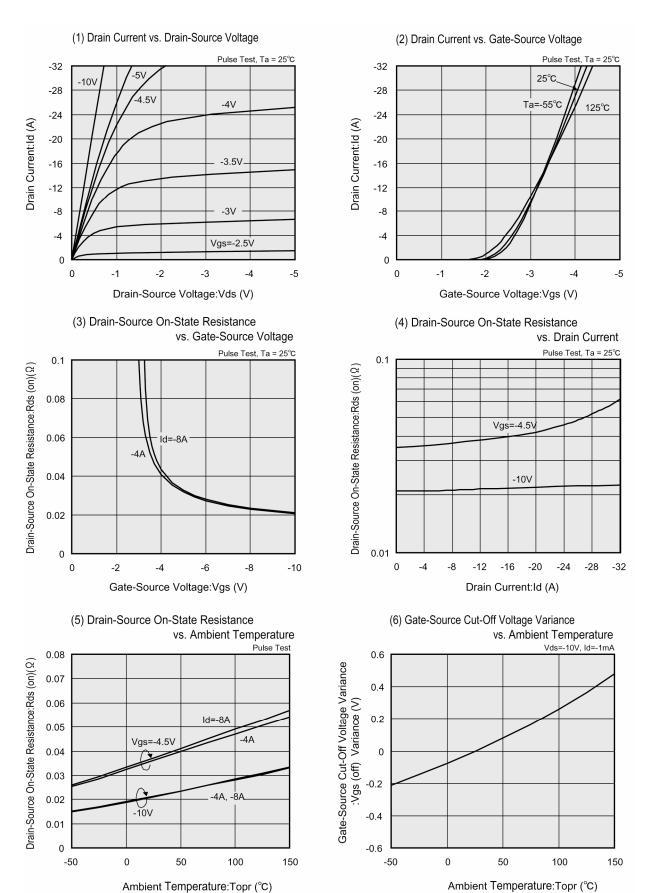
Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs=-5V, Id=-4A Vdd=-10V	ı	20	ı	ns
Rise Time	tr		-	45	-	ns
Turn-Off Delay Time	td (off)		=	40	-	ns
Fall Time	tf		-	35	-	ns

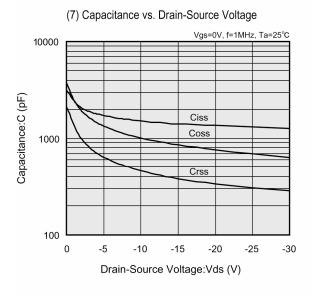
Thermal Characteristics

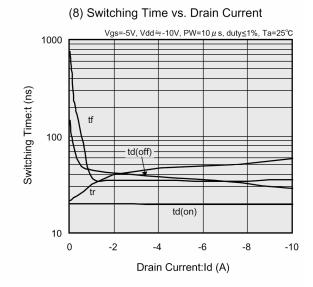
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a glass epoxy resin PCB	-	50	-	°C/W

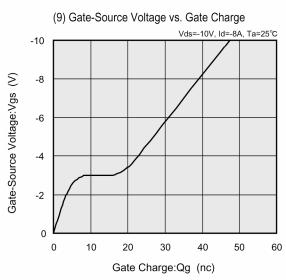
■TYPICAL PERFORMANCE CHARACTERISTICS

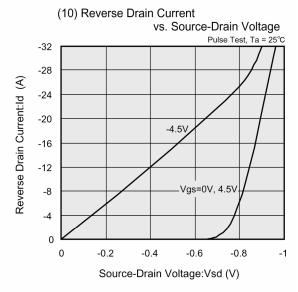


■TYPICAL PERFORMANCE CHARACTERISTICS (Cotinued)

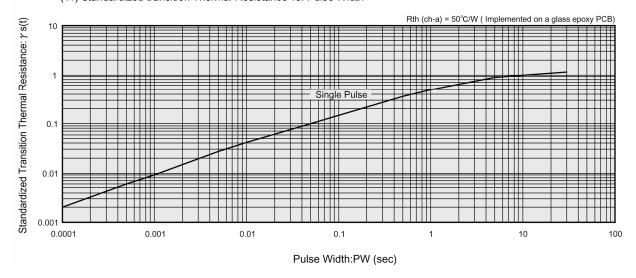








(11) Standardized transition Thermal Resistance vs. Pulse Width



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